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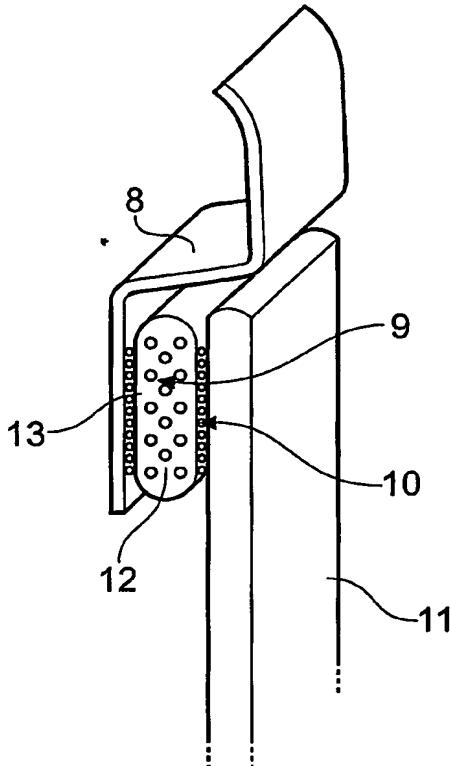
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(54) Title: METHOD AND APPARATUS FOR BONDING AND DEBONDING ADHESIVE INTERFACE SURFACES



(57) Abstract: The present invention relates to a system and a method of improving the debonding of two or more surfaces together. The invention utilises thermoeexpandable microspheres and thermal energy to debond interfaces in an adhesive system or as vehicle carriers. It also discloses a method of curing the adhesive system prior to the debonding step so that the same adhesive system may be used for both phases. It is especially useful in the automotive industry for end of vehicle life dismantling.



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